

4.3 Schematic

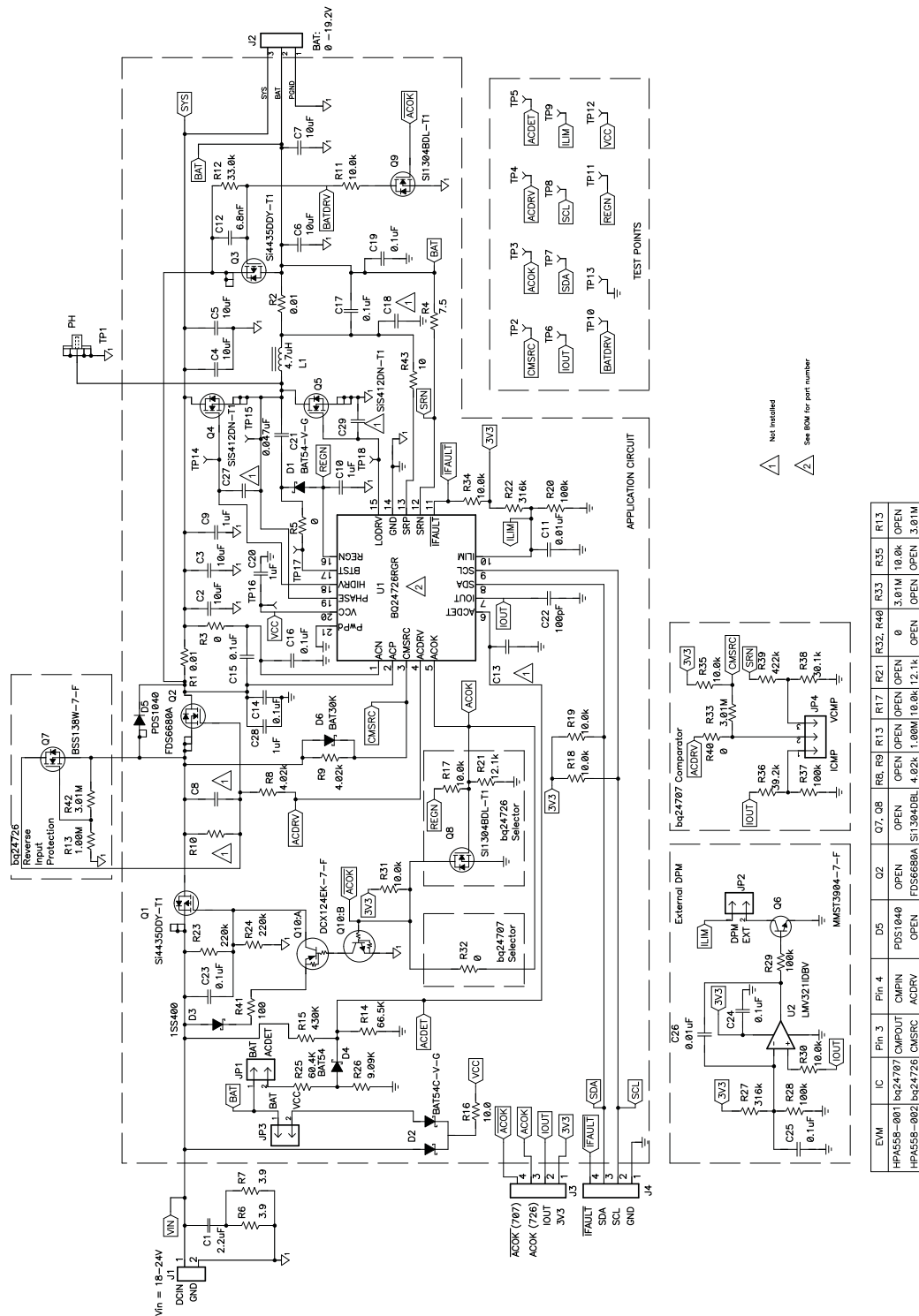


Figure 11. Schematic

EVM	IC	Pin 3	Pin 4	D5	C2	Q7, Q8	R8, R9	R13	R17	R21	R22, R46	R33	R35	R13
HPA558-001	bq24707	CMPOUT	CMPIN	FDS1040	OPEN	OPEN	OPEN	OPEN	OPEN	OPEN	0	3.01M	10.0k	OPEN
HPA558-002	bq24726	CMNSRC	ACDRV	FDS6680A	OPEN	FDS6680A	4.62k	1.00M	10.0k	4.62k	1.00M	10.0k	OPEN	3.01M

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